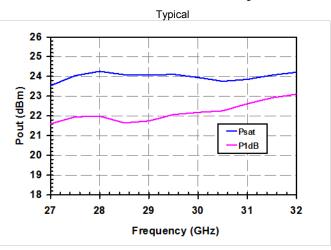


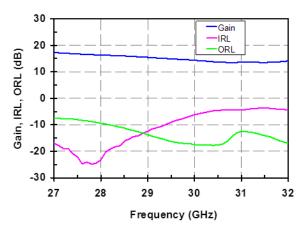
# **Ka-Band Medium Power Amplifier**



#### **Measured Performance**

Bias conditions: Vd = 5 V, Id = 170 mA, Vg = -0.6 V,





## **Key Features**

Frequency Range: 27 - 32 GHzPsat: 24 dBm, P1dB: 22 dBm

Gain: 15 dB

Return Loss: 10 dB

 Bias: Vd = 5 V, Id = 170 mA, Vg = -0.6 V Typical

5.

Package Dimensions: 4 x 4 x 0.85 mm

## **Primary Applications**

- Vsat and Digital Radio
- Point-to-Multipoint Communications

### **Product Description**

The TriQuint TGA4903-SM is a Ka-Band packaged medium Power Amplifier. The TGA4903-SM operates from 27-32 GHz and is designed using TriQuint's proven standard pHEMT production process.

The TGA4903-SM typically provides 22 dBm of output power at 1 dB gain compression, with small signal gain of 15 dB.

The TGA4903-SM is ideally suited for VSAT ground terminals, Point-to-Point Radios and Point-to-Multipoint communications.

Evaluation Boards are available.

Lead-free and RoHS compliant.

Datasheet subject to change without notice.



# Table I

# Absolute Maximum Ratings 1/

Symbol	Parameter	Value	Notes
Vd-Vg	Drain to Gate Voltage	12 V	
Vd	Drain Voltage	8 V	<u>2</u> /
Vg1 Vg2	Gate #1 Voltage Range Gate #2 Voltage Range	-5 to 0 V -5 to 0 V	
ld1 ld2	Drain #1 Current Drain #2Current	352 mA 320 mA	<u>2</u> /
lg1 lg2	Gate #1 Current Range Gate #2 Current Range	-0.9 to 16.5 mA -0.8 to 15 mA	
Pin	Input Continuous Wave Power	18 dBm	<u>2</u> /
Tchannel	Channel Temperature	200 °C	

- These ratings represent the maximum operable values for this device. Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device and / or affect device lifetime. These are stress ratings only, and functional operation of the device at these conditions is not implied.
- 2/ Combinations of supply voltage, supply current, input power, and output power shall not exceed the maximum power dissipation listed in Table IV.

# Table II Recommended Operating Conditions

Symbol	Parameter <u>1</u> /	Value
Vd	Drain Voltage	5 V
ld	Drain Current	170 mA
Id_Drive	Drain Current under RF Drive 300 mA	
Vg Gate Voltage -0.6 V		-0.6 V

1/ See Bias Procedures section for bias instructions.





# Table III RF Characterization Table

SYMBOL	PARAMETER	TEST CONDITIONS	MIN	NOMINAL	UNITS
Gain	Small Signal Gain	f = 27 GHz	13	16	dB
Gain	Small Signal Gain	f = 28-30 GHz	12	15	dB
Gain	Small Signal Gain	f = 31-32 GHz	11	14	dB
IRL	Input Return Loss	f = 27-32 GHz		10	dB
ORL	Output Return Loss	f = 27-32 GHz		10	dB
Psat	Saturated Output Power	f = 27-32 GHz	22	24	dBm
P1dB	Output Power @ 1dB Compression	f = 27-32 GHz		22	dBm
TOI	Output TOI	f = 27-32 GHz		27	dBm
NF	Noise Figure	f = 27-32 GHz		12	dB

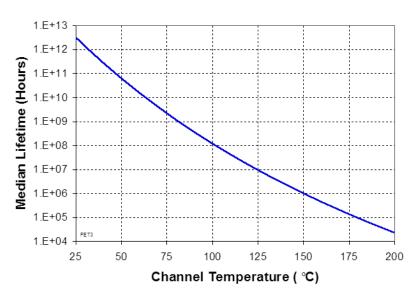


# Table IV Power Dissipation and Thermal Properties

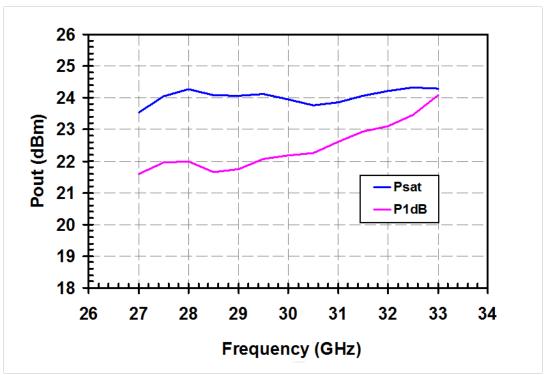
Parameter	Test Conditions	Value	Notes
Maximum Power Dissipation	Tbaseplate = 70°C	Pd = 2.0 W Tchannel = 200 °C Tm = 2.3 E4 Hrs	<u>1</u> / <u>2</u> /
Thermal Resistance, θjc	Vd = 5 V Id = 170 mA Pd = 0.85 W Tbaseplate = 70 °C	θjc = 65.2 °C/W Tchannel = 125 °C Tm = 9.13 E6 Hrs	
Thermal Resistance, θjc Under RF Drive	Vd = 5 V Id = 300 mA Pout = 24.5 dBm Pd = 1.25 W Tbaseplate = 70 °C	θjc = 65.2 °C/W Tchannel = 151 °C Tm = 8.92 E5 Hrs	
Mounting Temperature	30 Seconds	320 °C	
Storage Temperature		-65 to 150 °C	

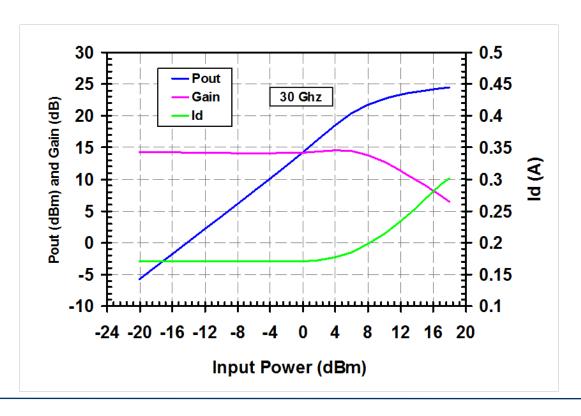
- $\underline{1}$ / For a median life of 1E+6 hours, Power Dissipation is limited to
  - $Pd(max) = (150 °C Tbase °C)/\theta jc.$
- 2/ Channel operating temperature will directly affect the device lifetime. For maximum life, it is recommended that channel temperatures be maintained at the lowest possible levels.

# Median Lifetime (Tm) vs. Channel Temperature

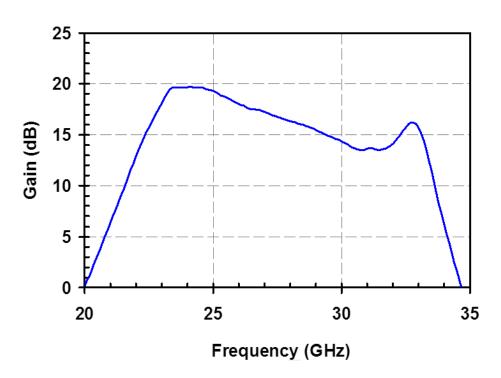


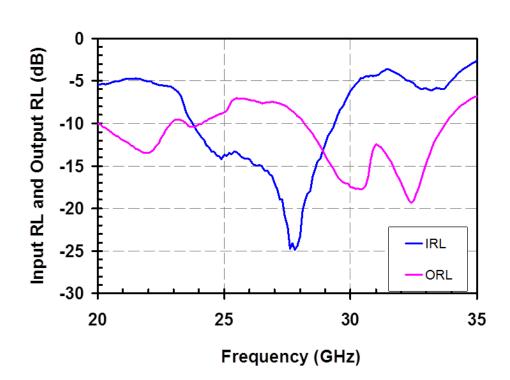




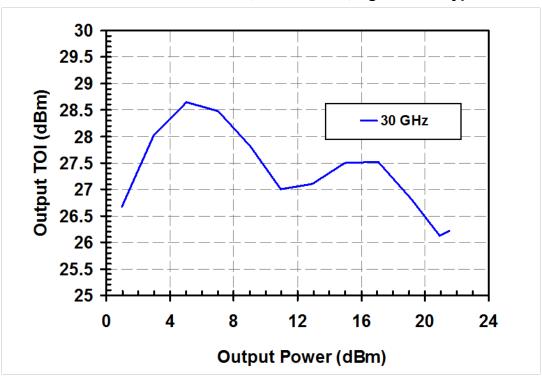


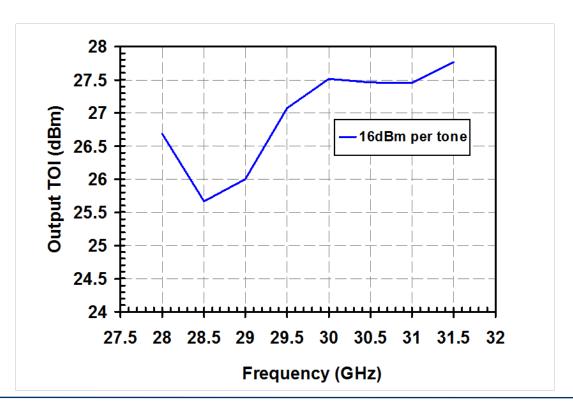




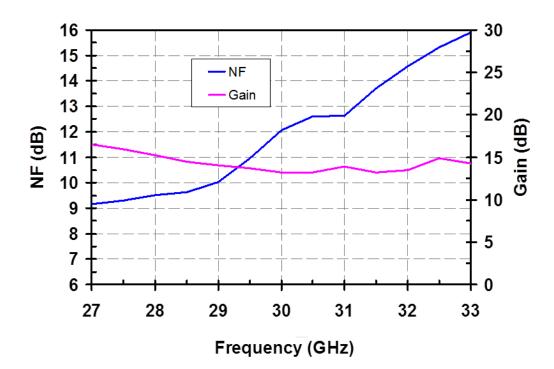








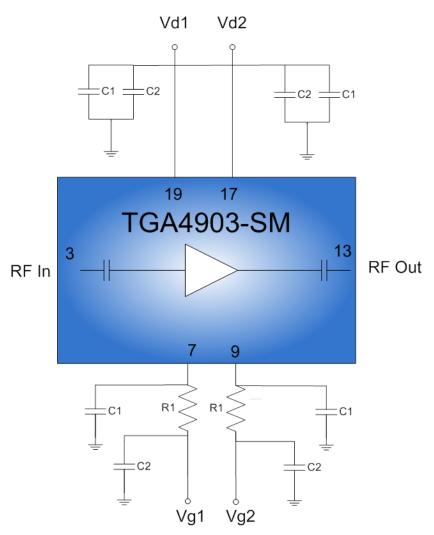








#### **Electrical Schematic**



#### **Bias Procedures**

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#### **Bias-down Procedure**

Connect Vg1 and Vg2 together. ("Vg") Connect Vd1 and Vd2 together. ("Vd") Turn off RF supply

Vg set to -1.5 V

Reduce Vg to -1.5V. Ensure Id ~ 0 mA

Vd set to +5 V

Turn Vd to 0 V

Adjust Vg more positive until Id is 170 mA. This will

Turn Vg to 0 V

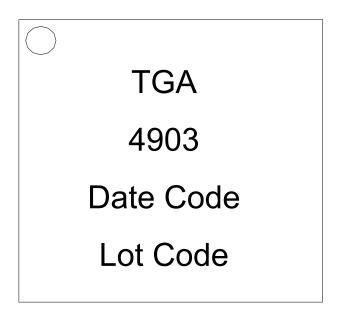
be  $\sim Vg = -0.6 V$ 

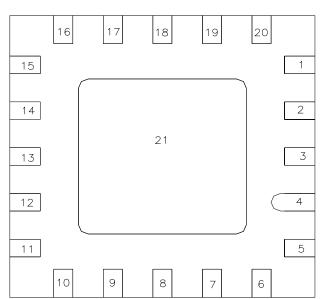
Apply RF signal to input





# **Package Pinout Diagram**





Top View

Dot indicates Pin 1

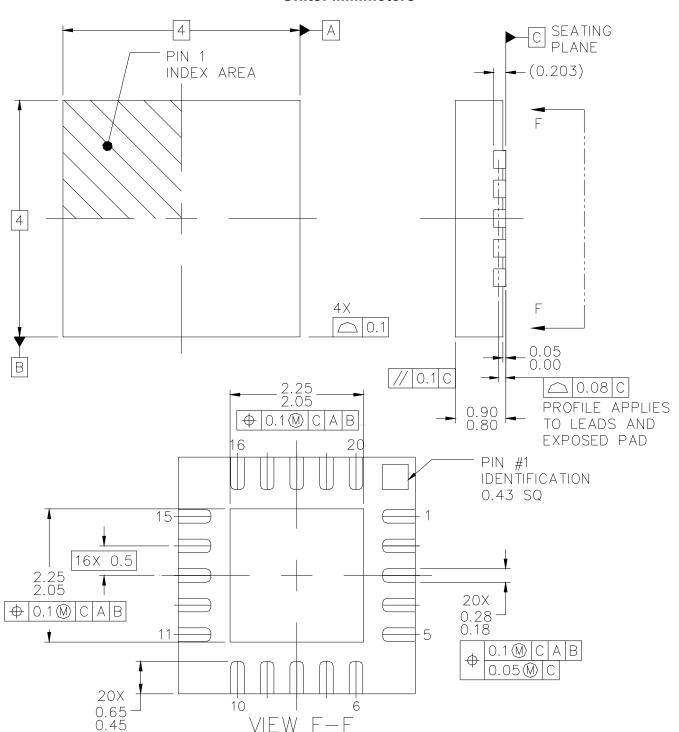
**Bottom View** 

Pin	Description
1, 2, 4, 5, 6, 10, 11, 12, 14, 15, 16, 20, 21	GND
8,18	NC
3	RF Input
7	Vg1
9	Vg2
13	RF Output
17	Vd2
19	Vd1



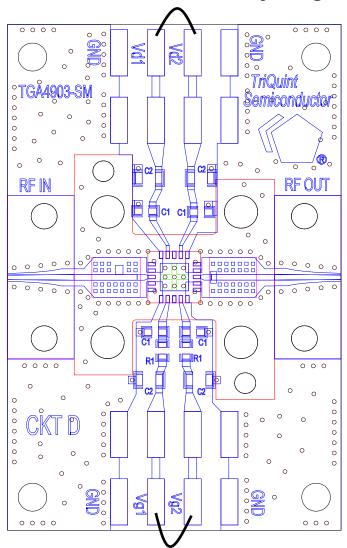
#### Mechanical Drawing Units: Millimeters

# **TGA4903-SM**





# **Recommended Assembly Diagram**



• C1: 0402 100pF cap

• C2: 0603 1uF cap

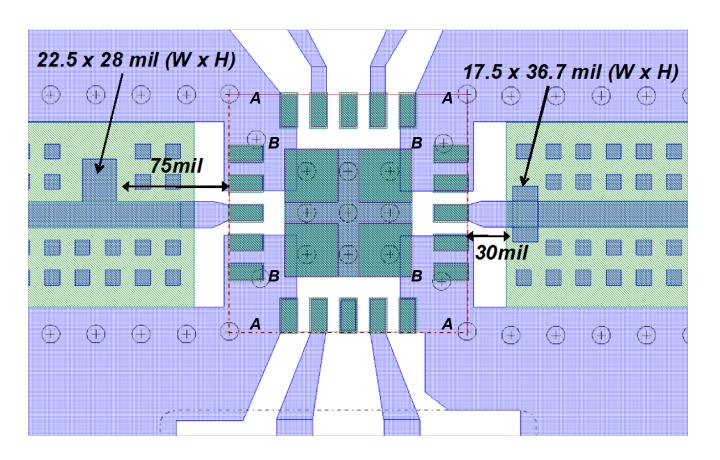
• R1: 0402 10 ohm resistor

In / Out tuning stubs for gain & power improvements

 Rogers RO4003C 8mil thick with 0.5oz cladding



## **Recommended Board Tuning for Maximum Output Power**



NOTE: Ground vias located at sites A and B, above, and grounded metal pads on PCB top metal, located under the package "GND" pads (see page 10), are critical for RF performance



### **Assembly Notes**

Recommended Surface Mount Package Assembly

- Proper ESD precautions must be followed while handling packages.
- Clean the board with alcohol. Allow the circuit to fully dry.
- TriQuint recommends using a conductive solder paste for attachment. Follow solder paste and reflow oven vendors' recommendations when developing a solder reflow profile. Typical solder reflow profiles are listed in the table below.
- Hand soldering is not recommended. Solder paste can be applied using a stencil printer or dot
  placement. The volume of solder paste depends on PCB and component layout and should be well
  controlled to ensure consistent mechanical and electrical performance.
- Clean the assembly with alcohol.

Reflow Profile	SnPb	Pb Free	
Ramp-up Rate	3 °C/sec	3 °C/sec	
Activation Time and Temperature	60 – 120 sec @ 140 – 160 °C	60 – 180 sec @ 150 – 200 °C	
Time above Melting Point	60 – 150 sec	60 – 150 sec	
Max Peak Temperature	240 °C	260 °C	
Time within 5 °C of Peak Temperature	10 – 20 sec	10 – 20 sec	
Ramp-down Rate	4 – 6 °C/sec	4 – 6 °C/sec	

### **Ordering Information**

Part	Package Style	
TGA4903-SM	QFN 4x4 Surface Mount	